

Docket Number (Optional) NEC 03P198	Application Number 181757,172
Applicant(s) OKADA	
Filing Date January 14, 2004	Group Art Unit 2823

[illegible][illegible]

9/18		Bhusari, et al. "Fabrication of Air-Gaps Between Cu Interconnects for Low Intralevel k" D4. 8 MRS symposium proceedings Vol. 612, 2000.

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